

## EMIF08-VID01C2

## 8 line low capacitance EMI filter and ESD protection

### Main product characteristics

Where EMI filtering in ESD sensitive equipment is required:

- LCD and camera for mobile phones
- Computers and printers
- Communication systems
- MCU Boards

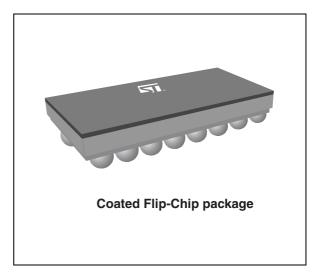
### Description

The EMIF08-VID01C2 is an 8 line highly integrated device designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interference. The Flip-Chip packaging means the package size is equal to the die size.

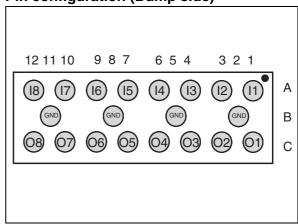
This filter includes ESD protection circuitry, which prevents damage to the application when it is subjected to ESD surges up to 15 kV.

#### **Benefits**

- High efficiency EMI filter (-33 dB @ 900 MHz)
- Low line capacitance suitable for high speed data bus
- Low serial resistance for camera impedance adaptation
- Optimized PCB space consuming: 1.29 mm x 3.92 mm
- Very thin package: 0.695 mm
- Coating resin on back side and lead free package
- High efficiency in ESD suppression on inputs pins (IEC 61000-4-2 level 4).
- High reliability offered by monolithic integration
- High reducing of parasitic elements through integration & wafer level packaging.



#### Pin configuration (Bump side)



#### **Complies with following standards:**

IEC 61000-4-2

level 4 input pins 15 kV (air discharge)

8 kV (contact discharge

level 1 output pins 2 kV (air discharge)

2 kV (contact discharge

MIL STD 883E - Method 3015-6 Class 3

Characteristics EMIF08-VID01C2

## 1 Characteristics

Figure 1. Basic cell configuration

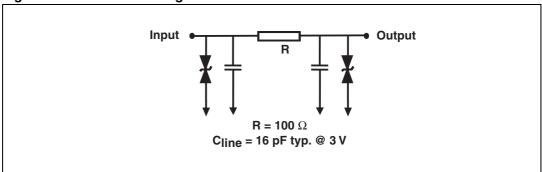


Table 1. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit
$V_{pp}$	ESD discharge IEC 61000-4-2 air discharge ESD discharge IEC 61000-4-2 contact discharge	15 8	kV kV
Tj	Maximum junction temperature	125	°C
T <sub>op</sub>	Operating temperature range	-40 to +85	°C
T <sub>stg</sub>	Storage temperature range	-55 to +150	°C

Table 2. Electrical characteristics ( $T_{amb} = 25^{\circ} C$ )

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Symbol	Parameters		
V <sub>BR</sub>	Breakdown voltage		
I <sub>RM</sub>	Leakage current @ V <sub>RM</sub>	I <sub>RM</sub>	
V <sub>RM</sub>	Stand-off voltage		v
R	Series resistance between input and output		
C <sub>line</sub>	Input capacitance per line		

Symbol	Test conditions	Min	Тур	Max	Unit
V <sub>BR</sub>	I <sub>R</sub> = 1 mA	6	8	10	V
I <sub>RM</sub>	V <sub>RM</sub> = 3 V per line			500	nA
R <sub>I/O</sub>	I = 10 mA	80	100	120	Ω
C <sub>line</sub>	V <sub>R</sub> = 3 V DC, 1 MHz		16	19	pF

EMIF08-VID01C2 Characteristics

Figure 2. S21 (dB) attenuation measurement Figure 3. Analog crosstalk measurement

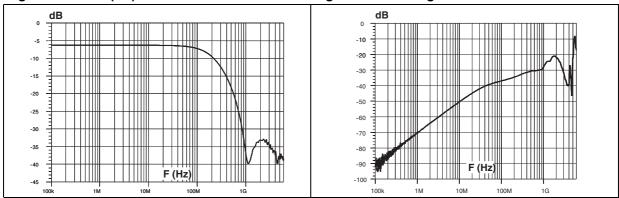


Figure 4. ESD response to IEC 61000-4-2 (+15 kV air discharge) on one input V<sub>in</sub> and one output V<sub>out</sub>

Figure 5. ESD response to IEC 61000-4-2 (- 15 kV air discharge) on one input V<sub>in</sub> and one output V<sub>out</sub>

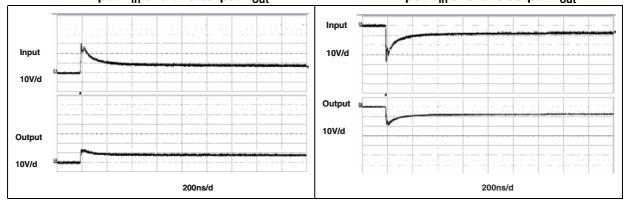
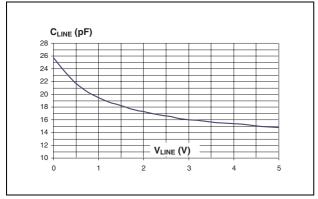
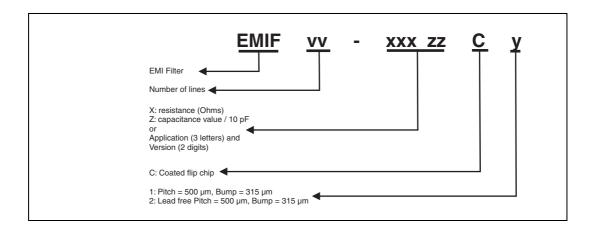


Figure 6. Line capacitance versus applied voltage



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# 2 Ordering information scheme



# 3 Package information

Figure 7. Flip-Chip Dimensions

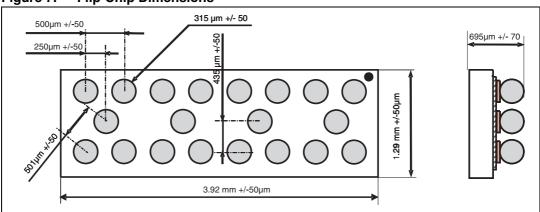
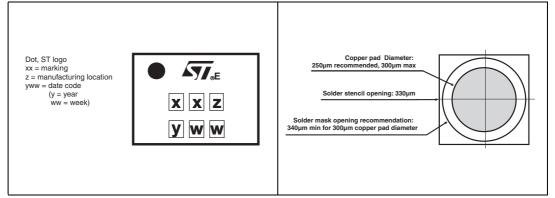


Figure 8. Marking

Figure 9. Footprint recommendation



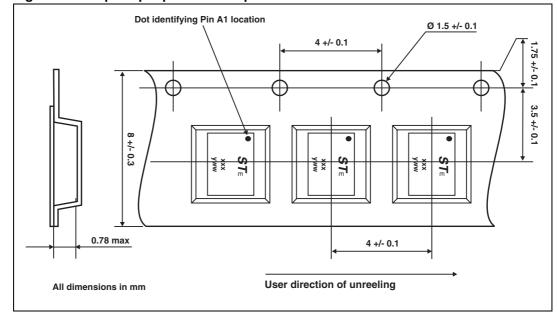


Figure 10. Flip-Chip tape and reel specification

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

## 4 Ordering information

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
EMIF08-VID01C2 GS		Flip-Chip	7.4mg	4000	7" Tape and reel

### 5 Revision history

Date	Revision	Changes
13-Jul-2005	1	Initial release.
11-Aug-2005	2	Fonts changed in Figures 7, 8, and 9.
31-May-2006	3	Reformatted to current standards. Depth dimension changed in Figure 10.
26-Oct-2006	4	Base quantity changed to 4000 in Ordering information

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